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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/935,255	08/22/2001	Ronald A. Weimer	MTI-31529	1208	
31870	7590 11/19/200	2			
WHYTE H	WHYTE HIRSCHBOECK DUDEK S.C.			EXAMINER	
111 E. WISCONSIN AVE. SUITE 2100			CHEN, JACK S J		
MILWAUK	EE, WI 53202		ART UNIT	PAPER NUMBER	
			2813	2813	
			DATE MAILED: 11/19/2002		

Please find below and/or attached an Office communication concerning this application or proceeding.





Application No. 09/935,255 Applicant(s)

Art Unit



Weimer

Office Action Summary

		Jack Chen	2813				
	The MAILING DATE of this communication appears	on the cover sheet with the corres	pondence addre	PSS			
	or Reply						
THE N	ORTENED STATUTORY PERIOD FOR REPLY IS SET MAILING DATE OF THIS COMMUNICATION. ions of time may be available under the provisions of 37 CFR 1.136 (a). In date of this communication.	_		S from the			
- If the p - If NO p - Failure - Any re	period for reply specified above is less than thirty (30) days, a reply within the seriod for reply is specified above, the maximum statutory period will apply to reply within the set or extended period for reply will, by statute, cause to ply received by the Office later than three months after the mailing date of patent term adjustment. See 37 CFR 1.704(b).	and will expire SIX (6) MONTHS from the mailing the application to become ABANDONED (35 U.S.)	ng date of this commu S.C. § 133).	inication.			
Status							
1) X	Responsive to communication(s) filed on Sep 3, 20	002		·			
2a) 🗌	This action is FINAL . 2b) X This ac	tion is non-final.					
3) 🗌	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11; 453 O.G. 213.						
Disposi	tion of Claims						
4) 💢	Claim(s) 1-57 and 73-96	is/are	e pending in the	e application.			
4	a) Of the above, claim(s)	is/ar	e withdrawn fr	om consideration.			
5) 🗆	Claim(s)		is/are allowed.				
6) 🗌	Claim(s)		is/are rejected				
7) 🗌	Claim(s)		is/are objected	to.			
8) X	Claims 1-57 and 73-96						
Applica	ition Papers						
9) 🗆	The specification is objected to by the Examiner.						
10)	The drawing(s) filed on is/ar	e a) \square accepted or b) \square object	ed to by the Ex	aminer.			
	Applicant may not request that any objection to the	_		i			
11)	The proposed drawing correction filed on	is: a) approved	b) disapprov	ved by the Examiner.			
	If approved, corrected drawings are required in reply	to this Office action.					
12) The oath or declaration is objected to by the Examiner.							
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgement is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a) All b) Some* c) None of:							
	1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No3. Copies of the certified copies of the priority documents have been received in this National Stage							
*S	3. Copies of the certified copies of the priority application from the International Bur see the attached detailed Office action for a list of t	eau (PCT Rule 17.2(a)).	Tins rational	otago			
14)	Acknowledgement is made of a claim for domesti	ic priority under 35 U.S.C. § 119	(e).				
a)[\square The translation of the foreign language provision	nal application has been received					
15)	Acknowledgement is made of a claim for domesti	ic priority under 35 U.S.C. §§ 12	0 and/or 121.				
Attachm							
_	otice of References Cited (PTO-892)	4) Interview Summary (PTO-413) Paper					
3) [_] In	formation Disclosure Statement(s) (PTO-1449) Paper No(s).	6) Uther:					

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DETAILED ACTION

Election/Restriction

1. This application contains claims directed to the following patentably distinct species of the claimed invention:

Species 1, claims 1-17 drawn to method for forming silicon nitride barrier by exposing the silicon layer to nitrogen-containing species.

Species 2, claim 18 drawn to method for forming silicon nitride barrier by thermally annealing the silicon layer in nitrogen-containing species.

Species 3, claims 19-22 drawn to method for forming silicon nitride barrier by nitridizing the silicon layer.

Species 4, claims 23-24 drawn to method for forming nitride barrier by exposing the silicon layer to a plasma source of a nitrogen-containing species.

Species 5, claims 25-26 drawn to method for forming nitride barrier by exposing the silicon layer to a remote microwave plasma source of a nitrogen-containing species.

Species 6, claim 27 drawn to method for forming nitride barrier by exposing the silicon layer to an inductive couple plasma source of a nitrogen-containing species.

Species 7, claims 28-35, 36, 38 drawn to method for forming a semiconductor device by nucleating the dielectric layer with silicon.

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Species 8, claim 37 drawn to method for forming a semiconductor device by nucleating the dielectric layer with silicon and thermally annealing the silicon with nitrogen-containing gas.

Species 9, claims 39-40 drawn to method for forming a semiconductor device by nucleating the dielectric layer with silicon and exposing the silicon to a plasma source of a nitrogen-containing species.

Species 10, claim 41 drawn to method for forming a semiconductor device by nucleating the dielectric layer with silicon and exposing the silicon to a remote microwave plasma source of a nitrogen-containing species.

Species 11, claims 42-44 drawn to method for forming a gate electrode by nucleating the dielectric layer with silicon.

Species 12, claim 45 drawn to method for forming a gate electrode by thermally annealing the silicon layer in a nitrogen-containing species.

Species 13, claim 46 drawn to method for forming a gate electrode by nitridizing the silicon layer.

Species 14, claims 47-48 drawn to method for forming a gate electrode by using specific parameters.

Species 15, claims 49-50 drawn to method for forming a gate electrode by exposing the silicon layer to a plasma source of a nitrogen-containing species.

Species 16, claim 51 drawn to method for forming a gate electrode by exposing the silicon layer to a remote microwave plasma source of a nitrogen-containing species.

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Species 17, claim 52 drawn to method for forming a gate electrode by exposing the silicon layer to an inductive couple plasma source of a nitrogen-containing species.

Species 18, claims 53-57 drawn to method for forming a gate electrode by further forming polysilicon layer.

Species 19, claims 73-74 drawn to method for forming a nitride barrier layer by exposing the silicon to a nitrogen gas.

Species 20, claim 75 drawn to method for forming a nitride barrier layer by nucleating the dielectric with silicon and exposing the silicon to a nitrogen gas.

Species 21, claims 76-79 drawn to method for forming a nitride barrier layer by chemical vapor deposition and exposing the silicon to a nitrogen gas.

Species 22, claims 80 drawn to method for forming a nitride barrier layer having the specified thickness by nucleating the dielectric layer with silicon and thermally annealing the silicon in a nitrogen gas.

Species 23, claims 81-82 drawn to method for forming a nitride barrier layer by nucleating the dielectric layer with silicon and thermally annealing the silicon in a nitrogen gas.

Species 24, claims 83-84 drawn to method for forming a nitride barrier layer by using specific low pressure, thickness and thermally annealing the silicon in a nitrogen gas.

Species 25, claim 85 drawn to method for forming a nitride barrier layer by nitridizing the silicon with a plasma source of nitrogen.

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Species 26, claim 86 drawn to method for forming a gate electrode by exposing the silicon on the gate oxide to a nitrogen gas to form a silicon nitride layer over the gate oxide layer.

Species 27, claim 87 drawn to method for forming a gate electrode by using chemical vapor deposition and exposing the silicon on the gate oxide to a nitrogen gas to form a silicon nitride layer over the gate oxide layer.

Species 28, claim 88 drawn to method for forming a gate electrode by using specified parameters such as pressure and thickness.

Species 29, claim 89 drawn to method for forming a gate electrode by nucleating the gate oxide with silicon and thermally annealing the silicon in the nitrogen gas to form the silicon nitride over the gate oxide.

Species 30, claim 90 drawn to method for forming a gate electrode by using specified parameters such as pressure and thickness and nucleate the gate oxide with silicon and thermally annealing the silicon in the nitrogen gas to form the silicon nitride over the gate oxide.

Species 31, claim 91 drawn to method for forming a gate electrode by depositing the silicon and nitridizing the silicon on the gate oxide with a plasma source of nitrogen to form a silicon nitride barrier layer over the gate oxide.

Species 32, claims 92-96 drawn to method for forming a gate electrode by nucleating the gate oxide with silicon and forming a conductive layer over the silicon nitride barrier layer.

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- 2. Applicant is required under 35 U.S.C. 121 to elect a single disclosed species for prosecution on the merits to which the claims shall be restricted if no generic claim is finally held to be allowable. Currently, no claims are generic.
- 3. Applicant is advised that a reply to this requirement must include an identification of the species that is elected consonant with this requirement, and a listing of all claims readable thereon, including any claims subsequently added. An argument that a claim is allowable or that all claims are generic is considered nonresponsive unless accompanied by an election.
- 4. Upon the allowance of a generic claim, applicant will be entitled to consideration of claims to additional species which are written in dependent form or otherwise include all the limitations of an allowed generic claim as provided by 37 CFR 1.141. If claims are added after the election, applicant must indicate which are readable upon the elected species. MPEP § 809.02(a).
- 5. Should applicant traverse on the ground that the species are not patentably distinct, applicant should submit evidence or identify such evidence now of record showing the species to be obvious variants or clearly admit on the record that this is the case. In either instance, if the examiner finds one of the inventions unpatentable over the prior art, the evidence or admission may be used in a rejection under 35 U.S.C. 103(a) of the other invention.
- 6. Applicant is advised that the reply to this requirement to be complete must include an election of the invention to be examined even though the requirement be traversed (37 CFR 1.143).

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7. Applicant is reminded that upon the cancellation of claims to a non-elected invention, the

inventorship must be amended in compliance with 37 CFR 1.48(b) if one or more of the currently

named inventors is no longer an inventor of at least one claim remaining in the application. Any

amendment of inventorship must be accompanied by a petition under 37 CFR 1.48(b) and by the

fee required under 37 CFR 1.17(I).

8. Any inquiry concerning this communication or earlier communications from the examiner

should be directed to Jack Chen whose telephone number is (703) 308-5838. The examiner can

normally be reached on Monday-Friday (alternate Monday off) from 8:30 am to 6:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Carl Whitehead, Jr., can be reached on (703)308-4940. The fax phone numbers for

the organization where this application or proceeding is assigned are 703-872-9318 for regular

Sarkell

communications and 703-872-9319 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding

should be directed to the receptionist whose telephone number is (703)308-0956.

Jack Chen

November 18, 2002

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